BSS83

MOSFET N-channel enhancement switching transistorRev. 03 — 21 November 2007Product data sheet

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Marking code: BSS83 = % M9

DESCRIPTION

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Symmetrical insulated-gate silicon MOS field-effect transistor of the N-channel enhancement mode type. The transistor is sealed in a SOT143 envelope and features a low ON resistance and low capacitances. The transistor is protected against excessive input voltages by integrated back-to-back diodes between gate and substrate.

APPLICATIONS

- analog and/or digital switch
- switch driver

PINNING

- 1 = substrate (b)
- 2 = source
- 3 = drain
- 4 = gate

Note

1. Drain and source are interchangeable.

QUICK REFERENCE DATA

Drain-source voltage	V _{DS}	max.	10 V
Source-drain voltage	V_{SD}	max.	10 V
Drain-substrate voltage	V_{DB}	max.	15 V
Source-substrate voltage	V _{SB}	max.	15 V
Drain current (DC)	I _D	max.	50 mA
Total power dissipation up to $T_{amb} = 25 \ ^{\circ}C$	P _{tot}	max.	230 mW
Gate-source threshold voltage			
$V_{DS} = V_{GS}; V_{SB} = 0;$	M	>	0.1 V
$I_D = 1 \ \mu A$	V _{GS(th)}	<	2.0 V
Drain-source ON-resistance			
V_{GS} = 10 V; V_{SB} = 0; I_{D} = 0.1 mA	R _{DSon}	<	45 Ω
Feed-back capacitance			
$V_{GS} = V_{BS} = -15 V;$			
V _{DS} = 10 V; f = 1 MHz	C _{rss}	typ.	0.6 pF

4

Top view

3

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MAM389

Fig.1 Simplified outline and symbol.

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RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Drain-source voltage	V _{DS}	max. 10 V
Source-drain voltage	V_{SD}	max. 10 V
Drain-substrate voltage	V_{DB}	max. 15 V
Source-substrate voltage	V_{SB}	max. 15 V
Drain current (DC)	I _D	max. 50 mA
Total power dissipation up to $T_{amb} = 25 \ ^{\circ}C^{(1)}$	P _{tot}	max. 230 mW
Storage temperature range	T _{stg}	–65 to + 150 °C
Junction temperature	Tj	max. 125 °C

THERMAL RESISTANCE

From junction to ambient in free air⁽¹⁾ $R_{th j-a} = 430 \text{ K/W}$

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CHARACTERISTICS				
T_{amb} = 25 °C unless otherwise specified				
Drain-source breakdown voltage				
$V_{GS} = V_{BS} = -5 \text{ V}; \text{ I}_{D} = 10 \text{ nA}$	V _{(BR)DSX}	>	10	V
Source-drain breakdown voltage				
$V_{GD} = V_{BD} = -5 \text{ V}; I_D = 10 \text{ nA}$	V _{(BR)SDX}	>	10	V
Drain-substrate breakdown voltage				
$V_{GB} = 0$; $I_D = 10$ nA; open source	V _{(BR)DBO}	>	15	V
Source-substrate breakdown voltage				
V _{GB} = 0; I _D = 10 nA; open drain	V _{(BR)SBO}	>	15	V
Drain-source leakage current				
$V_{GS} = V_{BS} = -2$ V; $V_{DS} = 6,6$ V	I _{DSoff}	<	10	nA
Source-drain leakage current				
$V_{GD} = V_{BD} = -2 V; V_{SD} = 6,6 V$	I _{SDoff}	<	10	nA
Forward transconductance at f = 1 kHz				
V _{DS} = 10 V; V _{SB} = 0; I _D = 20 mA	>	10	mS	
	g fs	typ.	15	mS
Gate-source threshold voltage				
$V_{DS} = V_{GS}; V_{SB} = 0; I_D = 1 \ \mu A$		>	0,1	V
	V _{GS(th)}	<	2,0	V
Drain-source ON-resistance				
I _D = 0,1 mA;				
$V_{GS} = 5 V; V_{SB} = 0$	R _{DSon}	<	70	Ω
V _{GS} = 10 V; V _{SB} = 0	R _{DSon}	<	45	Ω
V _{GS} = 3,2 V; V _{SB} = 6,8 V (see Fig.4)		typ.	80	Ω
	R _{DSon}	<	120	Ω
Gate-substrate zener voltages				
$V_{DB} = V_{SB} = 0; -I_G = 10 \mu A$	V _{Z(1)}	>	12,5	V
$V_{DB} = V_{SB} = 0; +I_G = 10 \mu\text{A}$	V _{Z(2)}	>	12,5	V
Capacitances at f = 1 MHz	_(_)			
V _{GS} = V _{BS} = -15 V; V _{DS} = 10 V				
Feed-back capacitance	C _{rss}	typ.	0,6	рF
Input capacitance	C _{iss}	typ.		pF
Output capacitance	C _{oss}	typ.	1,0	
Switching times (see Fig.2)				-
$V_{DD} = 10 \text{ V}; \text{ V}_{i} = 5 \text{ V}$	t _{on}	typ.	1,0	ns
	t _{off}	typ.	5,0	
	-011	.71	-,•	-

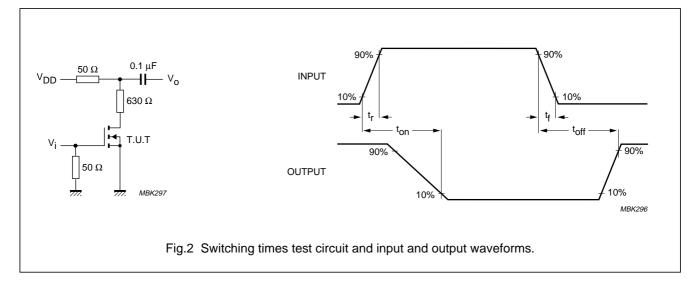
Note

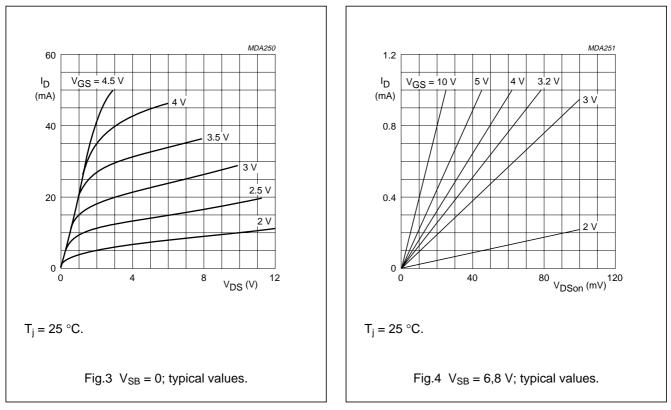
1. Device mounted on a ceramic substrate of 8 mm \times 10 mm \times 0,7 mm.

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Pulse generator:

Ri	=	50	Ω
t _r	<	0,5	ns
t _f	<	1,0	ns
tp	=	20	ns
δ	<	0,01	

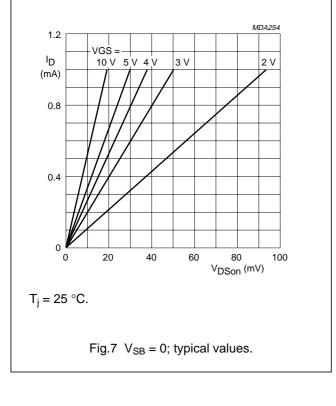




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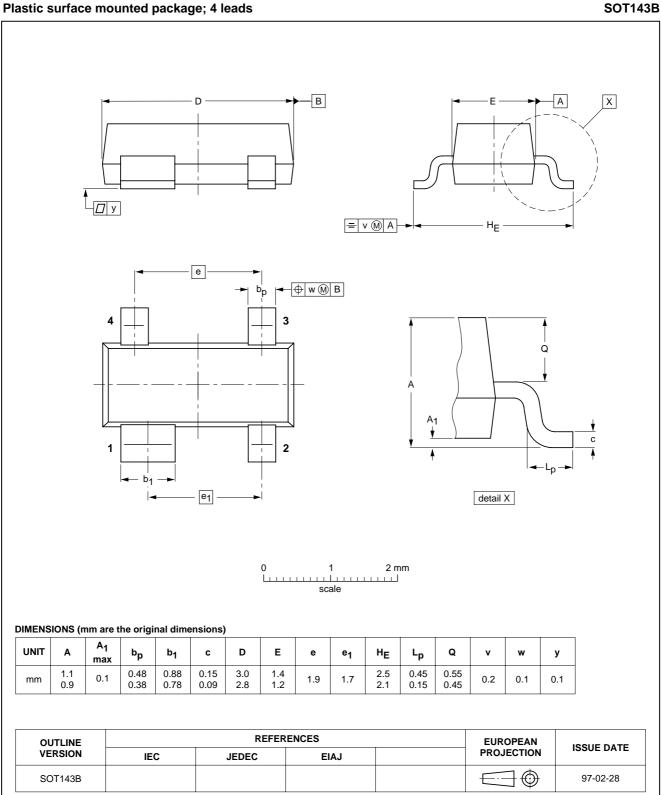
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MDA252 MDA253 50 12 I_D $V_{SB} = 0 V 4 V 12 V$ (mA) I_{D} 40 (mA) ⁄ 8 V 8 30 20 4 10 0 0 ³ V_{GS} (V) ⁴ ³ V_{GSth} (V) ⁴ 1 2 0 1 2 T_j = 25 °C. T_i = 25 °C. Fig.5 V_{DS} = 10 V; V_{BS} = 0; typical values. Fig.6 $V_{DS} = V_{GS} = V_{GS(th)}$.





PACKAGE OUTLINE



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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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Revision history

Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BSS83_N_3	20071121	Product data sheet	-	BSS83_CNV_2
Modifications: • Page 2; column 2; Marking code; row 1 changed				
BSS83_CNV_2	19910401	Product specification	-	-

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